LT5558



FEATURES

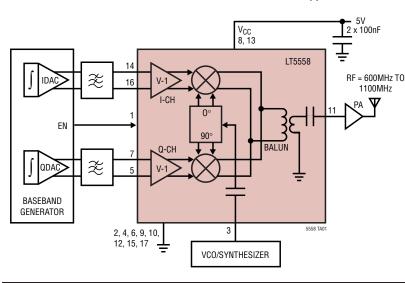
- Direct Conversion from Baseband to RF
- High OIP3: + 22.4dBm at 900MHz
- Low Output Noise Floor at 20MHz Offset: No RF: –158dBm/Hz
 - $P_{OUT} = 4dBm: -152.7dBm/Hz$
- Low Carrier Leakage: –43.7dBm at 900MHz
- High Image Rejection: –49dBc at 900MHz
- 3 Channel CDMA2000 ACPR: -70.4dBc at 900MHz
- Integrated LO Buffer and LO Quadrature Phase Generator
- 50 Ω AC-Coupled Single-ended LO and RF Ports
- High Impedance Interface to Baseband Inputs with 2.1V Common Mode Voltage
- 16-Lead QFN 4mm × 4mm Package

APPLICATIONS

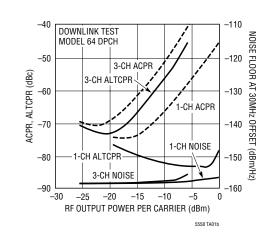
- RFID Single-Sideband Transmitters
- Infrastructure T_X for Cellular and ISM Bands
- Image Reject Up-Converters for Cellular Bands
- Low-Noise Variable Phase-Shifter for 600MHz to 1100MHz Local Oscillator Signals
- Microwave Links

TYPICAL APPLICATION

600MHz to 1100MHz Direct Conversion Transmitter Application



CDMA2000 ACPR, AltCPR and Noise vs RF Output Power at 900MHz for 1 and 3 Carriers



600MHz to 1100MHz High Linearity Direct Quadrature Modulator

DESCRIPTION

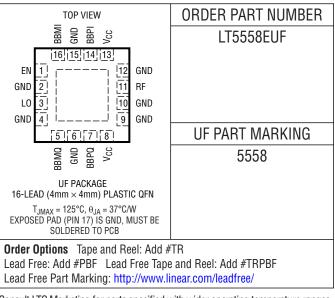
The LT[®]5558 is a direct I/Q modulator designed for high performance wireless applications, including wireless infrastructure. It allows direct modulation of an RF signal using differential baseband I and Q signals. It supports GSM, EDGE, CDMA, CDMA2000, and other systems. It may also be configured as an image reject upconverting mixer, by applying 90° phase-shifted signals to the I and Q inputs. The high impedance I/Q baseband inputs consist of voltage-to-current converters that in turn drive doublebalanced mixers. The outputs of these mixers are summed and applied to an on-chip RF transformer, which converts the differential mixer signals to a 50Ω single-ended output. The balanced I and Q baseband input ports are intended for DC coupling from a source with a common-mode voltage level of about 2.1V. The LO path consists of an LO buffer with single-ended input, and precision quadrature generators which produce the LO drive for the mixers. The supply voltage range is 4.5V to 5.25V.

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ABSOLUTE MAXIMUM RATINGS

| (Note 1) |
|---|
| Supply Voltage5.5V |
| Common-Mode Level of BBPI, BBMI and |
| BBPQ, BBMQ2.5V |
| Voltage on any Pin |
| Not to Exceed– 500 mV to (V _{CC} + 500 mV) |
| Operating Ambient Temperature |
| (Note 2) –40°C to 85°C |
| Storage Temperature Range–65°C to 125°C |
| |

PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS $V_{CC} = 5V$, EN = High, $T_A = 25^{\circ}C$, $f_{LO} = 900$ MHz, $f_{RF} = 902$ MHz, $P_{LO} = 0$ dBm. BBPI, BBMI, BBPQ, BBMQ CM input voltage = $2.1V_{DC}$, baseband input frequency = 2MHz, I and Q 90° shifted (upper sideband selection). $P_{PE}(0|T) = -10$ dBm, unless otherwise noted. (Note 3)

| SYMBOL | PARAMETER | CONDITIONS | MIN TYP MAX | UNITS | |
|------------------------|-----------------------------------|---|---------------------------|----------------------------|--|
| RF Output (R | RF) | | | | |
| f _{RF} | RF Frequency Range | -3 dB Bandwidth -1 dB Bandwidth | 600 to 1100 680 to 960 | MHz MHz | |
| S _{22, ON} | RF Output Return Loss | EN = High (Note 6) | -15.8 | dB | |
| S _{22, OFF} | RF Output Return Loss | EN = Low (Note 6) | -13.3 | dB | |
| NFloor | RF Output Noise Floor | No Input Signal (Note 8) P _{RF} = 4dBm (Note 9) P _{RF} = 4dBm (Note 10) | -158 -152.7 -152.3 | dBm/Hz dBm/Hz dBm/Hz | |
| G _P | Conversion Power Gain | P _{OUT} /P _{IN,I&Q} | 9.7 | dB | |
| G _V | Conversion Voltage Gain | 20 • Log (V _{OUT} , _{50Ω} /V _{IN, DIFF, I or Q}) | -5.1 | dB | |
| P _{OUT} | Absolute Output Power | $1V_{P-P DIFF}$ CW Signal, I and Q | -1.1 | dBm | |
| G _{3L0 vs L0} | 3 • LO Conversion Gain Difference | (Note 17) | -26.5 | dB | |
| OP1dB | Output 1dB Compression | (Note 7) | 7.8 | dBm | |
| 0IP2 | Output 2nd Order Intercept | (Notes 13, 14) | 65 | dBm | |
| OIP3 | Output 3rd Order Intercept | (Notes 13, 15) | 22.4 | dBm | |
| IR | Image Rejection | (Note 16) | -49 | dBc | |
| LOFT | Carrier Leakage | EN = High, P _{LO} = 0dBm (Note 16) | -43.7 | dBm | |
| | (LO Feedthrough) | $EN = Low, P_{LO} = OdBm$ (Note 16) | -60 | dBm | |
| EVM | GSM Error Vector Magnitude | P _{RF} = 2dBm | 0.6 | % | |
| LO Input (LO |) | | i | | |
| f _{LO} | LO Frequency Range | | 600 to 1100 | MHz | |
| P _{L0} | LO Input Power | | -10 0 5 | dBm | |



ELECTRICAL CHARACTERISTICS $V_{CC} = 5V$, EN = High, $T_A = 25^{\circ}C$, $f_{LO} = 900$ MHz, $f_{RF} = 902$ MHz, $P_{LO} = 0$ dBm. BBPI, BBMI, BBPQ, BBMQ CM input voltage = $2.1V_{DC}$, baseband input frequency = 2MHz, I and Q 90° shifted (upper sideband selection). $P_{RF(OUT)} = -10$ dBm, unless otherwise noted. (Note 3)

| SYMBOL | PARAMETER | CONDITIONS | MIN | ТҮР | MAX | UNITS |
|-----------------------|--|--|-------------|-------|------|-----------------------|
| S _{11, ON} | LO Input Return Loss | EN = High (Note 6) | | -10.6 | | dB |
| S _{11, OFF} | LO Input Return Loss | EN = Low (Note 6) | -2.5 | | | dB |
| NF _{LO} | LO Input Referred Noise Figure | (Note 5) at 900MHz | | 14.6 | | dB |
| G _{L0} | LO to RF Small-Signal Gain | (Note 5) at 900MHz | | 16.4 | | dB |
| IIP3 _{L0} | LO Input 3rd Order Intercept | (Note 5) at 900MHz | | -3.3 | | dBm |
| Baseband In | puts (BBPI, BBMI, BBPQ, BBMQ) | | | | | |
| BW _{BB} | Baseband Bandwidth | -3dB Bandwidth | | 400 | | MHz |
| V _{CMBB} | DC Common-mode Voltage | (Note 4) | | 2.1 | | V |
| R _{IN, DIFF} | Differential Input Resistance | Between BBPI and BBMI (or BBPQ and BBMQ) | | 3 | | kΩ |
| R _{IN, CM} | Common Mode Input Resistance | (Note 20) | | 100 | | Ω |
| Ісм, сомр | Common Mode Compliance Current range | (Notes 18, 20) | -820 to 440 | | | μΑ |
| P _{LO-BB} | Carrier Feedthrough on BB | $P_{OUT} = 0$ (Note 4) | -46 | | | dBm |
| IP1dB | Input 1dB compression point | Differential Peak-to-Peak (Notes 7, 19) | 3.4 | | | V _{P-P,DIFF} |
| $\Delta G_{I/Q}$ | I/Q Absolute Gain Imbalance | | 0.05 | | | dB |
| Δφι/Q | I/Q Absolute Phase Imbalance | | 0.2 | | | Deg |
| Power Supply | / (V _{CC}) | | | | | |
| V _{CC} | Supply Voltage | | 4.5 | 5 | 5.25 | V |
| I _{CC(ON)} | Supply Current | EN = High | | 108 | 135 | mA |
| I _{CC(OFF)} | Supply Current, Sleep mode | EN = 0V | | 0.1 | 50 | μΑ |
| t _{ON} | Turn-On Time | EN = Low to High (Note 11) | | 0.3 | | μS |
| t _{OFF} | Turn-Off Time | EN = High to Low (Note 12) | 1.1 | | | μS |
| Enable (EN), | Low = Off, High = On | • | | | | |
| Enable | Input High Voltage Input High Current | EN = High EN = 5V | 1 | 230 | | V 4 µA |
| Shutdown | Input Low Voltage | EN = Low | | | 0.5 | V |

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: Specifications over the -40°C to 85°C temperature range are assured by design, characterization and correlation with statistical process controls.

Note 3: Tests are performed as shown in the configuration of Figure 7.

Note 4: At each of the four baseband inputs BBPI, BBMI, BBPQ and BBMQ.

Note 5: $V_{BBPI} - V_{BBMI} = 1V_{DC}$, $V_{BBPQ} - V_{BBMQ} = 1V_{DC}$.

Note 6: Maximum value within -1dB bandwidth.

Note 7: An external coupling capacitor is used in the RF output line.

Note 8: At 20MHz offset from the LO signal frequency.

Note 9: At 20MHz offset from the CW signal frequency.

Note 10: At 5MHz offset from the CW signal frequency.

Note 11: RF power is within 10% of final value.

Note 12: RF power is at least 30dB lower than in the ON state.

Note 13: Baseband is driven by 2MHz and 2.1MHz tones. Drive level is set in such a way that the two resulting RF tones are -10dBm each.

Note 14: IM2 measured at LO frequency + 4.1MHz

Note 15: IM3 measured at LO frequency + 1.9MHz and LO frequency + 2.2MHz.

Note 16: Amplitude average of the characterization data set without image or LO feedthrough nulling (unadjusted).

Note 17: The difference in conversion gain between the spurious signal at $f = 3 \cdot LO - BB$ versus the conversion gain at the desired signal at f = LO + IOBB for BB = 2MHz and LO = 900MHz.

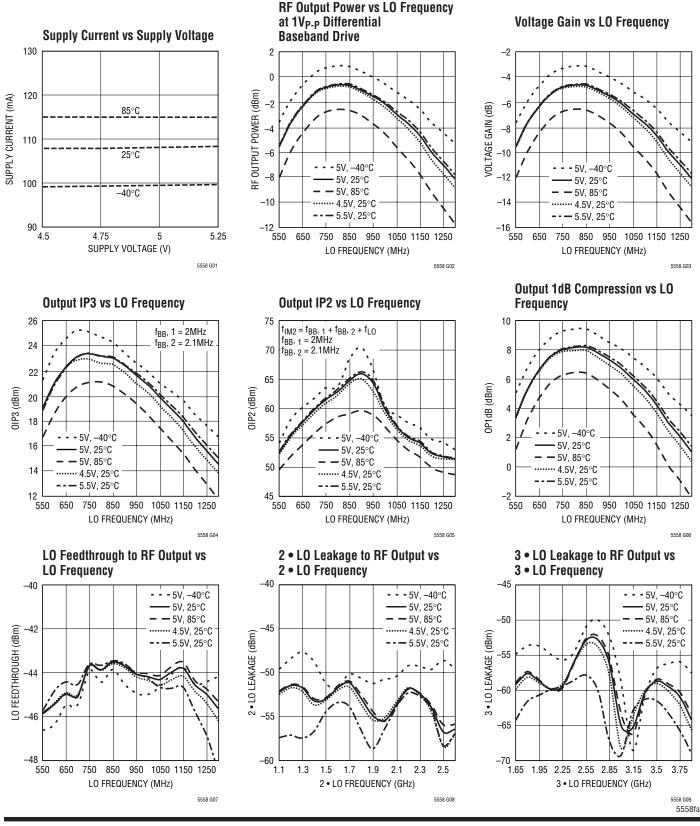
Note 18: Common mode current range where the common mode (CM) feedback loop biases the part properly. The common mode current is the sum of the current flowing into the BBPI (or BBPQ) pin and the current flowing into the BBMI (or BBMQ) pin.

Note 19: The input voltage corresponding to the output P1dB.

Note 20: BBPI and BBMI shorted together (or BBPQ and BBMQ shorted together).



TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC} = 5V$, EN = High, $T_A = 25^{\circ}C$, $f_{LO} = 900MHz$, $f_{RF} = 902MHz$, $P_{LO} = 0dBm$. BBPI, BBMI, BBPQ, BBMQ CM input voltage = $2.1V_{DC}$, baseband input frequency = 2MHz, I and Q 90° shifted, without image or LO feedthrough nulling. $f_{RF} = f_{BB} + f_{LO}$ (upper side-band selection). $P_{RF(OUT)} = -10dBm$ (-10dBm/tone for 2-tone measurements), unless otherwise noted. (Note 3)

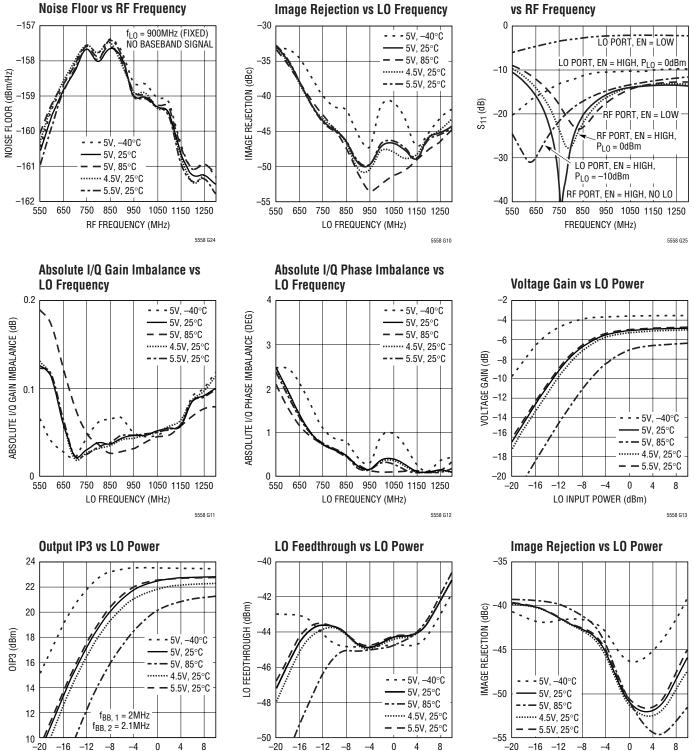




LO and RF Port Return Loss

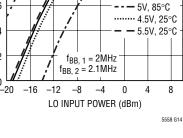
TYPICAL PERFORMANCE CHARACTERISTICS $v_{CC} = 5V$, EN = High, $T_A = 25^{\circ}C$, $f_{LO} = 900$ MHz, $f_{RF} = 902$ MHz, $P_{LO} = 0$ dBm. BBPI, BBMI, BBPQ, BBMQ CM input voltage = $2.1V_{DC}$, baseband input frequency = 2MHz, I and Q 90° shifted, without image or LO feedthrough nulling. $f_{RF} = f_{BB} + f_{LO}$ (upper side-band selection). $P_{RF(OUT)} = -10$ dBm (-10dBm/tone for

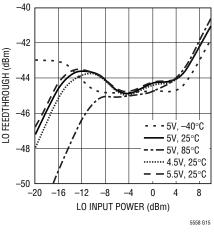
2-tone measurements), unless otherwise noted. (Note 3)



5558 G16

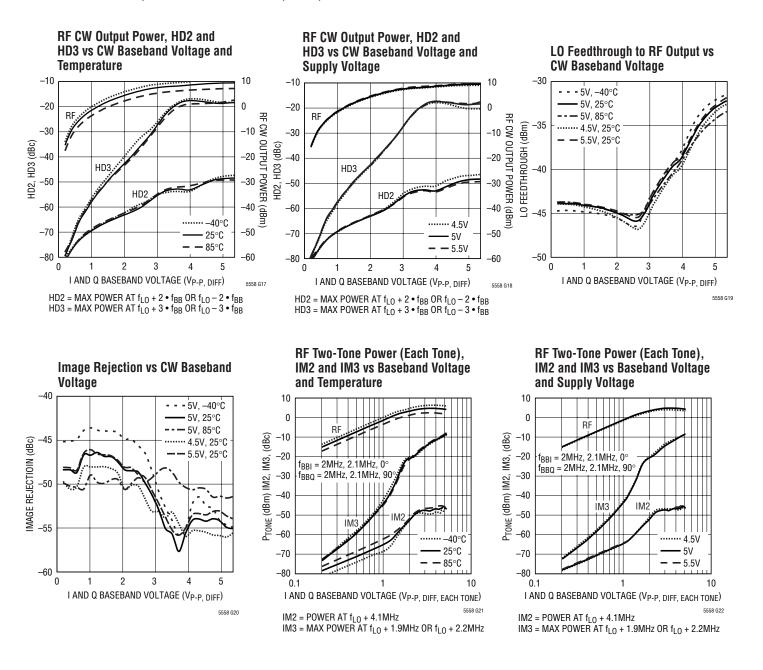
LO INPUT POWER (dBm)







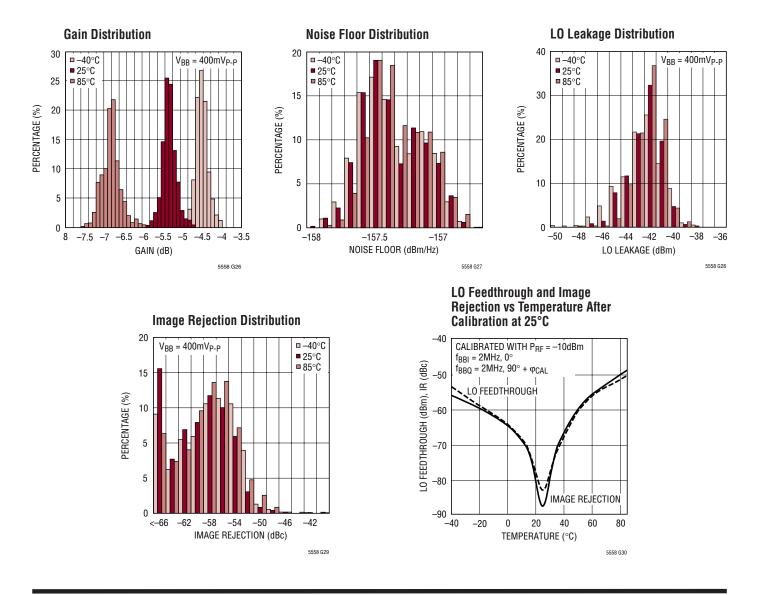
TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC} = 5V$, EN = High, $T_A = 25^{\circ}C$, $f_{LO} = 900$ MHz, $f_{RF} = 902$ MHz, $P_{LO} = 0$ dBm. BBPI, BBMI, BBPQ, BBMQ CM input voltage = $2.1V_{DC}$, baseband input frequency = 2MHz, I and Q 90° shifted, without image or LO feedthrough nulling. $f_{RF} = f_{BB} + f_{LO}$ (upper side-band selection). $P_{RF(OUT)} = -10$ dBm (-10dBm/tone for 2-tone measurements), unless otherwise noted. (Note 3)





TYPICAL PERFORMANCE CHARACTERISTICS $V_{CC} = 5V$, EN = High, $T_A = 25^{\circ}C$, $f_{LO} = 900$ MHz, $f_{RF} = 902$ MHz, $P_{LO} = 0$ dBm. BBPI, BBMI, BBPQ, BBMQ CM input voltage = $2.1V_{DC}$, baseband input frequency = 2MHz, I and Q 90°

 f_{RF} = 902MHz, P_{LO} = 0dBm. BBPI, BBMI, BBPQ, BBMQ CM input voltage = 2.1V_{DC}, baseband input frequency = 2MHz, I and Q 90° shifted, without image or LO feedthrough nulling. $f_{RF} = f_{BB} + f_{LO}$ (upper side-band selection). $P_{RF(OUT)} = -10$ dBm (-10dBm/tone for 2-tone measurements), unless otherwise noted. (Note 3)



PIN FUNCTIONS

EN (Pin 1): Enable Input. When the Enable pin voltage is higher than 1V, the IC is turned on. When the Enable voltage is less than 0.5V or if the pin is disconnected, the IC is turned off. The voltage on the Enable pin should never exceed V_{CC} by more than 0.5V, in order to avoid possible damage to the chip.

GND (Pins 2, 4, 6, 9, 10, 12, 15, 17): Ground. Pins 6, 9, 15 and the Exposed Pad, Pin 17, are connected to each

other internally. Pins 2 and 4 are connected to each other internally and function as the ground return for the LO signal. Pins 10 and 12 are connected to each other internally and function as the ground return for the on-chip RF balun. For best RF performance, Pins 2, 4, 6, 9, 10, 12, 15 and the Exposed Pad, Pin 17, should be connected to the printed circuit board ground plane.

PIN FUNCTIONS

LO (Pin 3): LO Input. The LO input is an AC-coupled singleended input with approximately 50Ω input impedance at RF frequencies. Externally applied DC voltage should be within the range -0.5V to (V_{CC} + 0.5V) in order to avoid turning on ESD protection diodes.

BBPQ, BBMQ (Pins 7, 5): Baseband Inputs for the Q-channel. The differential input impedance is $3k\Omega$. These pins are internally biased at about 2.1V. Applied common mode voltage must stay below 2.5V.

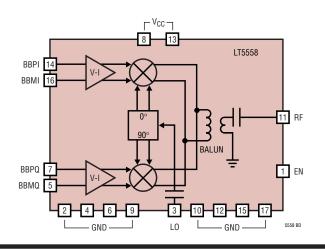
V_{CC} (Pins 8, 13): Power Supply. Pins 8 and 13 are connected to each other internally. It is recommended to use

 $0.1 \mu \text{F}$ capacitors for decoupling to ground on each of these pins.

RF (Pin 11): RF Output. The RF output is an AC-coupled single-ended output with approximately 50Ω output impedance at RF frequencies. Externally applied DC voltage should be within the range -0.5V to ($V_{CC} + 0.5V$) in order to avoid turning on ESD protection diodes.

BBPI, BBMI (Pins 14, 16): Baseband Inputs for the I-channel. The differential input impedance is $3k\Omega$. These pins are internally biased at about 2.1V. Applied common mode voltage must stay below 2.5V.

BLOCK DIAGRAM



APPLICATIONS INFORMATION

The LT5558 consists of I and Q input differential voltageto-current converters, I and Q up-conversion mixers, an RF output signal combiner/balun, an LO quadrature phase generator and LO buffers.

External I and Q baseband signals are applied to the differential baseband input pins, BBPI, BBMI, and BBPQ, BBMQ. These voltage signals are converted to currents and translated to RF frequency by means of double-balanced up-converting mixers. The mixer outputs are combined in an RF output balun, which also transforms the output impedance to 50Ω . The center frequency of the resulting RF signal is equal to the LO signal frequency. The LO input drives a phase shifter which splits the LO signal into in-phase and quadrature LO signals. These LO signals are then applied to on-chip buffers which drive the upconversion mixers. Both the LO input and RF output are single-ended, 50Ω -matched and AC coupled.

Baseband Interface

The baseband inputs (BBPI, BBMI), (BBPQ, BBMQ) present a differential input impedance of about $3k\Omega$. At each of the four baseband inputs, a low-pass filter using 200Ω and 1.8pF to ground is incorporated (see Figure 1), which limits the baseband –1dB bandwidth to approximately 250MHz. The common-mode voltage is about 2.1V and is slightly temperature dependent. At $T_A = -40^{\circ}$ C, the common-mode voltage is about 2.28V and at $T_A = 85^{\circ}$ C it is about 2.01V.





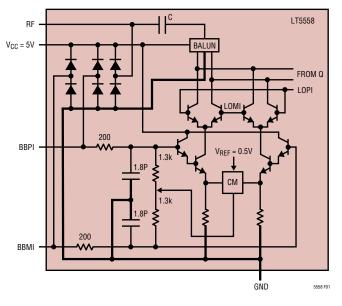
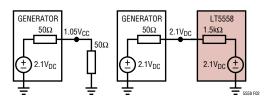


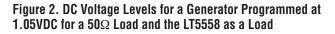
Figure 1. Simplifed Circuit Schematic of the LT5558 (Only I-Half is Drawn)

If the I/Q signals are DC-coupled to the LT5558, it is important that the applied common-mode voltage level of the I and Q inputs is about 2.1V in order to properly bias the LT5558. Some I/Q generators allow setting the common-mode voltage independently. In this case, the common-mode voltage of those generators must be set to 1.05V to match the LT5558 internal bias where the internal DC voltage of the signal generators is set to 2.1V due to the source-load voltage division (See Figure 2).

The LT5558 baseband inputs should be driven differentially, otherwise, the even-order distortion products will degrade the overall linearity severely. Typically, a DAC will be the signal source for the LT5558. A pulse-shaping filter should be placed between the DAC outputs and the LT5558's baseband inputs.

An AC-coupled baseband interface with the LT5558 is drawn in Figure 3. Capacitors C1 to C4 will introduce a





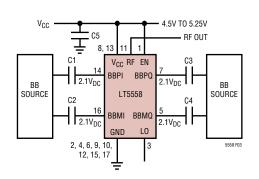


Figure 3. AC-Coupled Baseband Interface

low-frequency high-pass corner together with the LT5558's differential input impedance of $3k\Omega$. Usually, capacitors C1 to C4 will be chosen equal and in such a way that the -3dB corner frequency $f_{-3dB} = 1/(\pi \cdot R_{IN,DIFF} \cdot C1)$ is much lower than the lowest baseband frequency.

DC coupling between the DAC outputs and the LT5558 baseband inputs is recommended, because AC coupling will introduce a low-frequency time constant that may affect the signal integrity. Active level shifters may be required to adapt the common mode level of the DAC outputs to the common mode input voltage of the LT5558. Such circuits may, however, suffer degraded LO leakage performance as small DC offsets and variations over temperature accumulate. A better scheme is shown in Figure 16, where feedback is used to track out these variations.

LO Section

The internal LO input amplifier performs single-ended to differential conversion of the LO input signal. Figure 4 shows the equivalent circuit schematic of the LO input.

The internal, differential LO signal is split into in-phase and quadrature (90° phase shifted) signals that drive LO buffer sections. These buffers drive the double balanced I and Q mixers. The phase relationship between

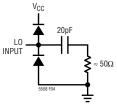


Figure 4. Equivalent Circuit Schematic of the LO Input



the LO input and the internal in-phase LO and quadrature LO signals is fixed, and is independent of start-up conditions. The phase shifters are designed to deliver accurate quadrature signals for an LO frequency near 900MHz. For frequencies significantly below 750MHz or above 1.1GHz, the quadrature accuracy will diminish, causing the image rejection to degrade. The LO pin input impedance is about 50Ω and the recommended LO input power window is -2dBm to +2dBm. For $P_{LO} < -2dBm$, the gain, OIP2, OIP3, dynamic-range (in dBc/Hz) and image rejection will degrade, especially at $T_A = 85^{\circ}C$.

Harmonics present on the LO signal can degrade the image rejection, because they introduce a small excess phase shift in the internal phase splitter. For the second (at 1.8GHz) and third harmonics (at 2.7GHz) at -20dBc level, the introduced signal at the image frequency is about -61dBc or lower, corresponding to an excess phase shift much less than 1 degree. For the second and third harmonics at -10dBc, still the introduced signal at the image frequency is about -51dBc. Higher harmonics than the third will have less impact. The LO return loss typically will be better than 10dB over the 750MHz to 1GHz range. Table 1 shows the LO port input impedance vs. frequency. The return loss S₁₁ on the LO port can be improved at lower frequencies by adding a shunt capacitor.

Table 1. LO Port Input Impedance vs Frequency for EN = High and P_{LO} = OdBm

| FREQUENCY | | \$ ₁₁ | |
|-----------|------------------------------|------------------|-------|
| (MHz) | INPUT IMPEDANCE (Ω) | MAG | ANGLE |
| 500 | 50.5 + j10.3 | 0.101 | 81.3 |
| 600 | 63.8 + j4.6 | 0.127 | 16.0 |
| 700 | 70.7 – j6.9 | 0.180 | -15.2 |
| 800 | 70.7 – j20.3 | 0.237 | -34.9 |
| 900 | 63.9 – j30.6 | 0.285 | -50.5 |
| 1000 | 56.7 – j32.2 | 0.295 | -61.4 |
| 1100 | 52.1 – j31.3 | 0.295 | -69.1 |
| 1200 | 46.3 – j32.0 | 0.318 | -78.0 |

The input impedance of the LO port is different if the part is in shutdown mode. The LO input impedance for EN = Low is given in Table 2.

| Table 2. LO Port Input Impedance vs Frequency for EN = Low | |
|--|--|
| and $P_{LO} = OdBm$ | |

| FREQUENCY | | S | 11 |
|-----------|------------------------------|-------|-------|
| (MHz) | INPUT IMPEDANCE (Ω) | MAG | ANGLE |
| 500 | 37.3 + j43.4 | 0.464 | 79.7 |
| 600 | 72.1 + j74.8 | 0.545 | 42.1 |
| 700 | 184.7 + j77.8 | 0.630 | 11.7 |
| 800 | 203.6 – j120.8 | 0.696 | -12.7 |
| 900 | 75.9 – j131.5 | 0.737 | -32.6 |
| 1000 | 36.7 – j99.0 | 0.760 | -48.8 |
| 1100 | 23.4 – j77.4 | 0.768 | -62.4 |
| 1200 | 17.8 – j62.8 | 0.764 | -74.3 |

RF Section

After up-conversion, the RF outputs of the I and Q mixers are combined. An on-chip balun performs internal differential to single-ended output conversion, while transforming the output signal impedance to 50Ω . Table 3 shows the RF port output impedance vs frequency.

Table 3. RF Port Output Impedance vs Frequency for EN = High and P_{L0} = 0dBm

| FREQUENCY | | S ₂₂ | |
|-----------|-------------------------------|-----------------|--------|
| (MHz) | OUTPUT IMPEDANCE (Ω) | MAG | ANGLE |
| 500 | 22.8 + j4.9 | 0.380 | 165.8 |
| 600 | 30.2 + j11.4 | 0.283 | 141.9 |
| 700 | 42.7 + j12.9 | 0.159 | 111.8 |
| 800 | 53.7 + j3.0 | 0.045 | 37.2 |
| 900 | 52.0 – j10.1 | 0.101 | -73.2 |
| 1000 | 44.8 – j15.2 | 0.168 | -99.7 |
| 1100 | 39.1 – j15.1 | 0.206 | -116.1 |
| 1200 | 35.7 – j13.1 | 0.224 | -128.9 |



The RF output S22 with no LO power applied is given in Table 4.

Table 4. RF Port Output Impedance vs Frequency for EN = High and No LO Power Applied

| FREQUENCY | | \$ ₂₂ | |
|-----------|-------------------------------|------------------|--------|
| (MHz)(| OUTPUT IMPEDANCE (Ω) | MAG | ANGLE |
| 500 | 23.4 + j5.0 | 0.367 | 165.5 |
| 600 | 31.7 + j10.7 | 0.257 | 142.0 |
| 700 | 44.1 + j9.5 | 0.118 | 116.1 |
| 800 | 50.9 – j1.7 | 0.019 | -60.8 |
| 900 | 46.8 – j11.1 | 0.118 | -99.3 |
| 1000 | 40.8 – j13.5 | 0.178 | -115.5 |
| 1100 | 36.6 – j12.6 | 0.209 | -128.1 |
| 1200 | 34.3 – j10.5 | 0.222 | -139.0 |

For EN = Low the S_{22} is given in Table 5.

To improve S_{22} for lower frequencies, a series capacitor can be added to the RF output. At higher frequencies, a shunt inductor can improve the S_{22} . Figure 5 shows the equivalent circuit schematic of the RF output.

 Table 5. RF Port Output Impedance vs Frequency for EN = Low

| ······································ | | | | |
|--|-------------------------------|------------------|--------|--|
| FREQUENCY | | \$ ₂₂ | | |
| (MHz) | OUTPUT IMPEDANCE (Ω) | MAG | ANGLE | |
| 500 | 21.8 + j4.8 | 0.398 | 166.5 | |
| 600 | 28.4 + j11.8 | 0.311 | 142.9 | |
| 700 | 40.2 + j15.4 | 0.200 | 112.9 | |
| 800 | 54.3 + j8.3 | 0.090 | 58.1 | |
| 900 | 56.7 – j7.2 | 0.092 | -43.3 | |
| 1000 | 49.2 – j15.8 | 0.158 | -83.8 | |
| 1100 | 41.9 – j17.0 | 0.203 | -105.0 | |
| 1200 | 37.3 – j15.3 | 0.225 | -120.0 | |

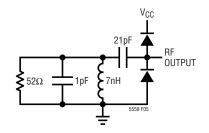


Figure 5. Equivalent Circuit Schematic of the RF Output

Note that an ESD diode is connected internally from the RF output to the ground. For strong output RF signal levels (higher than 3dBm), this ESD diode can degrade the linearity performance if an external 50Ω termination impedance is connected directly to ground. To prevent this, a coupling capacitor can be inserted in the RF output line. This is strongly recommended during 1dB compression measurements.

Enable Interface

Figure 6 shows a simplified schematic of the EN pin interface. The voltage necessary to turn on the LT5558 is 1V. To disable (shut down) the chip, the enable voltage must be below 0.5V. If the EN pin is not connected, the chip is disabled. This EN = Low condition is guaranteed by the 75k Ω on-chip pull-down resistor.

It is important that the voltage at the EN pin does not exceed V_{CC} by more than 0.5V. If this should occur, the full-chip supply current could be sourced through the EN pin ESD protection diodes, which are not designed for this purpose. Damage to the chip may result.

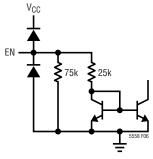


Figure 6. EN Pin Interface

Evaluation Board

Figure 7 shows the evaluation board schematic. A good ground connection is required for the LT5558's Exposed Pad. If this is not done properly, the RF performance will degrade. Additionally, the Exposed Pad provides heat sinking for the part and minimizes the possibility of the chip overheating. R1 (optional) limits the EN pin current in the event that the EN pin is pulled high while the V_{CC} inputs are low. The application board PCB layouts are shown in Figures 8 and 9.



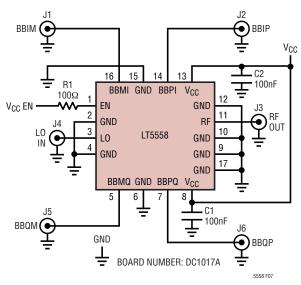


Figure 7. Evaluation Circuit Schematic

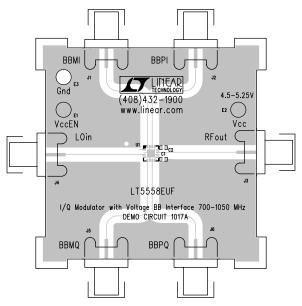


Figure 8. Component Side of Evaluation Board

Application Measurements

The LT5558 is recommended for base-station applications using various modulation formats. Figure 10 shows a typical application.

Figure 11 shows the ACPR performance for CDMA2000 using one and three channel modulation. Figures 12 and 13 illustrate the 1- and 3-channel CDMA2000 measurement. To calculate ACPR, a correction is made for the spectrum analyzer noise floor (Application Note 99).

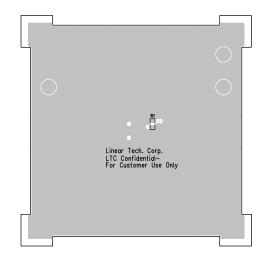


Figure 9. Bottom Side of Evaluation Board

If the output power is high, the ACPR will be limited by the linearity performance of the part. If the output power is low, the ACPR will be limited by the noise performance of the part. In the middle, an optimum ACPR is obtained.

Because of the LT5558's very high dynamic-range, the test equipment can limit the accuracy of the ACPR measurement. Consult Design Note 375 or the factory for advice on ACPR measurement if needed.

The ACPR performance is sensitive to the amplitude mismatch of the BBIP and BBIM (or BBQP and BBQM) inputs. This is because a difference in AC current amplitude will give rise to a difference in amplitude between the even-order harmonic products generated in the internal V-I converter. As a result, they will not cancel out entirely. Therefore, it is important to keep the amplitudes at the BBIP and BBIM (or BBQP and BBQM) inputs as equal as possible.

LO feedthrough and image rejection performance may be improved by means of a calibration procedure. LO feedthrough is minimized by adjusting the differential DC offset at the I and the Q baseband inputs. Image rejection can be improved by adjusting the gain and the phase difference between the I and the Q baseband inputs. The LO feedthrough and Image Rejection can also change as a function of the baseband drive level, as depicted in Figure 14.



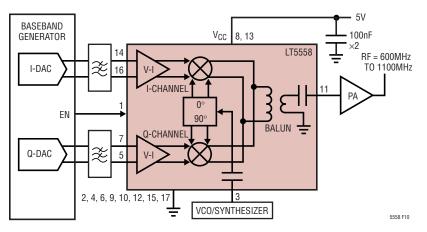


Figure 10. 600MHz to 1.1GHz Direct Conversion Transmitter Application

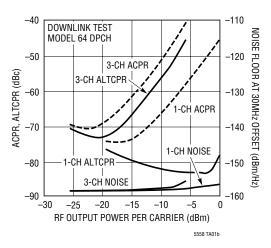


Figure 11. ACPR, ALTCPR and Noise for CDMA2000 Modulation

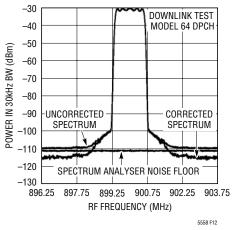


Figure 12. 1-Channel CDMA2000 Spectrum

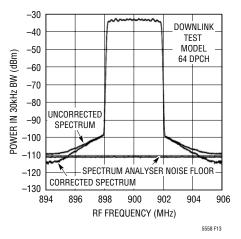


Figure 13. 3-Channel CDMA2000 Spectrum

Example: RFID Application

In Figure 15 the interface between the LTC1565 (U2, U3) and the LT5558 is designed for RFID applications. The LTC1565 is a seventh-order, 650kHz, continuous-time, linear-phase, lowpass filter. The optimum output common-mode level of the LTC1565 is about 2.5V and the optimum input common-mode level of the LT5558 is around 2.1V and is temperature dependent. To adapt the common-mode level of the LTC1565 to the LT5558, a level shift network consisting of R1 to R6 and R11 to R16 is used. The output common-mode level of the LTC1565 can be adjusted by overriding the internally generated voltage on pin 3 of the LTC1565.



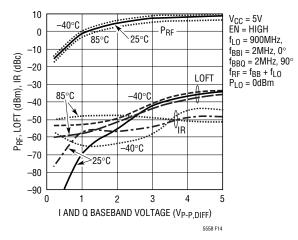


Figure 14. LO Feedthrough and Image Rejection vs Baseband Drive Voltage After Calibration at 25°C

The common-mode voltage on the LT5558 is sampled using resistors R7, R8, R17 and R18 and shifted up to about 2.5V using resistor R9. Op amp U4 compensates for the gain loss in the resistor networks and provides a low-ohmic drive to steer the common-mode input pins of U2 and U3. Resistors R20 and R21 improve op amp

U4's stability while driving the large supply decoupling capacitors C3 and C4. This corrected common-mode voltage is applied to the common-mode input pins of U2 and U3 (pins 3). This results in a positive feedback loop for the common mode voltage with a loop gain of about -10dB. This technique ensures that the current compliance on the baseband input pins of the LT5558 is not exceeded under supply voltage or temperature extremes, and internal diode voltage shifts or combinations of these. The core current of the LT5558 is thus maintained at its designed level for optimum performance. The recommended common-mode voltage applied to the inputs of the LTC1565 is about 2V. Resistor tolerances are recommended 1% accuracy or better. The total current consumption is about 160mA and the noise floor at 20MHz offset is -147dBm/Hz with 3.7dBm RF output power. For a 2VPP DIFF baseband input swing, the output power at f_{LO} + f_{BB} is 1.6dBm and the third harmonic at $f_{LO} - 3f_{BB}$ is -48.6dBm. For a $2.6V_{PP, DIFF}$ input, the output power at $f_{LO} + f_{BB}$ is 3.8dBmand the third harmonic at $f_{I,0} - 3f_{BB}$ is -40.5 dBm.

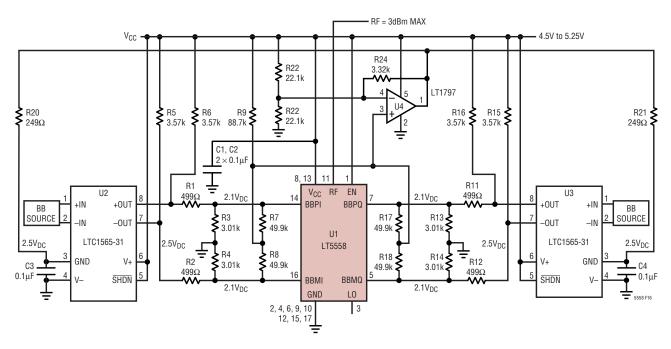
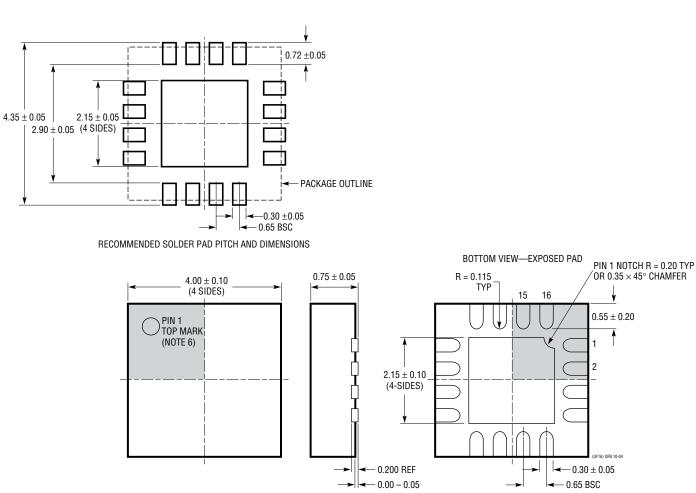


Figure 15. Baseband Interface Schematic of the LTC1565 with the LT5558 for RFID applications.





PACKAGE DESCRIPTION



UF Package 16-Lead Plastic QFN (4mm × 4mm) (Reference LTC DWG # 05-08-1692)

NOTE:

1. DRAWING CONFORMS TO JEDEC PACKAGE OUTLINE MO-220 VARIATION (WGGC)

2. DRAWING NOT TO SCALE

3. ALL DIMENSIONS ARE IN MILLIMETERS

4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE

MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE

5. EXPOSED PAD SHALL BE SOLDER PLATED

6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION

ON THE TOP AND BOTTOM OF PACKAGE



RELATED PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
|-----------------------|---|---|
| Infrastructure | 1 | |
| LT5511 | High Linearity Upconverting Mixer | RF Output to 3GHz, 17dBm IIP3, Integrated LO Buffer |
| LT5512 | DC to 3GHz High Signal Level Downconverting Mixer | DC to 3GHz, 17dBm IIP3, Integrated LO Buffer |
| LT5514 | Ultralow Distortion, IF Amplifier/ADC Driver with Digitally Controlled Gain | 850MHz Bandwidth, 47dBm OIP3 at 100MHz, 10.5dB to 33dB Gain Control Range |
| LT5515 | 1.5GHz to 2.5GHz Direct Conversion Quadrature Demodulator | 20dBm IIP3, Integrated LO Quadrature Generator |
| LT5516 | 0.8GHz to 1.5GHz Direct Conversion Quadrature Demodulator | 21.5dBm IIP3, Integrated LO Quadrature Generator |
| LT5517 | 40MHz to 900MHz Quadrature Demodulator | 21dBm IIP3, Integrated LO Quadrature Generator |
| LT5518 | 1.5GHz to 2.4GHz High Linearity Direct Quadrature Modulator | 22.8dBm OIP3 at 2GHz, –158.2dBm/Hz Noise Floor, 50Ω Single-Ended LO and RF Ports, 4-Ch W-CDMA ACPR = –64dBc at 2.14GHz |
| LT5519 | 0.7GHz to 1.4GHz High Linearity Upconverting Mixer | 17.1dBm IIP3 at 1GHz, Integrated RF Output Transformer with 50 Ω Matching, Single-Ended LO and RF Ports Operation |
| LT5520 | 1.3GHz to 2.3GHz High Linearity Upconverting Mixer | 15.9dBm IIP3 at 1.9GHz, Integrated RF Output Transformer with 50 Ω Matching, Single-Ended LO and RF Ports Operation |
| LT5521 | 10MHz to 3700MHz High Linearity Upconverting Mixer | 24.2dBm IIP3 at 1.95GHz, NF = 12.5dB, 3.15V to 5.25V Supply, Single-Ended LO Port Operation |
| LT5522 | 600MHz to 2.7GHz High Signal Level Downconverting Mixer | 4.5V to 5.25V Supply, 25dBm IIP3 at 900MHz, NF = 12.5dB, 50 Ω Single-Ended RF and LO Ports |
| LT5524 | Low Power, Low Distortion ADC Driver with Digitally Programmable Gain | 450MHz Bandwidth, 40dBm OIP3, 4.5dB to 27dB Gain Control |
| LT5526 | High Linearity, Low Power Downconverting Mixer | 3V to 5.3V Supply, 16.5dBm IIP3, 100kHz to 2GHz RF, NF = 11dB, I _{CC} = 28mA, –65dBm LO-RF Leakage |
| LT5527 | 400MHz to 3.7GHz High Signal Level Downconverting Mixer | IIP3 = 23.5dBm and NF = 12.5dB at 1900MHz, 4.5V to 5.25V Supply, I_{CC} = 78mA |
| LT5528 | 1.5GHz to 2.4GHz High Linearity Direct Quadrature Modulator | 21.8dBm OIP3 at 2GHz, –159.3dBm/Hz Noise Floor, 50Ω , 0.5V _{DC} Baseband Interface, 4-Ch W-CDMA ACPR = –66dBc at 2.14GHz |
| LT5568 | 700MHz to 1050MHz High Linearity Direct Quadrature Modulator | 22.9dBm OIP3 at 850MHz, –160.3dBm/Hz Noise Floor, 50Ω, 0.5V _{DC} Baseband Interface, 3-Ch CDMA2000 ACPR = –71.4dBc at 850MHz |
| LT5572 | 1.5GHz to 2.5GHz High Linearity Direct Quadrature Modulator | 21.6dBm OIP3 at 2GHz, –158.6dBm/Hz Noise Floor, High-Ohmic 0.5V _{DC} Baseband Interface, 4-Ch W-CDMA ACPR = –67.7dBc at 2.14GHz |
| RF Power Detec | tors | |
| LT5504 | 800MHz to 2.7GHz RF Measuring Receiver | 80dB Dynamic Range, Temperature Compensated, 2.7V to 5.25V Supply |
| LTC®5505 | RF Power Detectors with >40dB Dynamic Range | 300MHz to 3GHz, Temperature Compensated, 2.7V to 6V Supply |
| LTC5507 | 100kHz to 1000MHz RF Power Detector | 100kHz to 1GHz, Temperature Compensated, 2.7V to 6V Supply |
| LTC5508 | 300MHz to 7GHz RF Power Detector | 44dB Dynamic Range, Temperature Compensated, SC70 Package |
| LTC5509 | 300MHz to 3GHz RF Power Detector | 36dB Dynamic Range, Low Power Consumption, SC70 Package |
| LTC5530 | 300MHz to 7GHz Precision RF Power Detector | Precision V _{OUT} Offset Control, Shutdown, Adjustable Gain |
| LTC5531 | 300MHz to 7GHz Precision RF Power Detector | Precision V _{OUT} Offset Control, Shutdown, Adjustable Offset |
| LTC5532 | 300MHz to 7GHz Precision RF Power Detector | Precision V _{OUT} Offset Control, Adjustable Gain and Offset |
| LT5534 | 50MHz to 3GHz Loq RF Power Detector with 60dB Dynamic Range | ±1dB Output Variation over Temperature, 38ns Response Time |
| LTC5536 | Precision 600MHz to 7GHz RF Detector with Fast Comparater | 25ns Response Time, Comparator Reference Input, Latch Enable Input, –26dBm to +12dBm Input Range |
| LT5537 | Wide Dynamic Range Loq RF/IF Detector | Low Frequency to 800MHz, 83dB Dynamic Range, 2.7V to 5.25V Supply |
| High Speed ADC | | |
| LTC2220-1 | 12-Bit, 185Msps ADC | Single 3.3V Supply, 910mW Consumption, 67.5dB SNR, 80dB SFDR, 775MHz Full Power BW |
| LTC2249 | 14-Bit, 80Msps ADC | Single 3V Supply, 222mW Consumption, 73dB SNR, 90dB SFDR |
| LTC2255 | 14-Bit, 125Msps ADC | Single 3V Supply, 395mW Consumption, 72.4dB SNR, 88dB SFDR, 640MHz Full Power BW |
| | | 5558f |

